

# ACKNOWLEDGEMENT RECEIPT

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**Title of  
Invention**

MULTI-LAYER INTEGRATED SEMICONDUCTOR STRUCTURE

Submission Type : Information Disclosure  
Statement

Application Number:

10/655854



EFS ID:

69798

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ISVR1	Submission was successfully submitted - Even if Informational or Warning Messages appear below, please do not resubmit this application
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First Named Applicant: Rafael Reif

Attorney Docket Number: MIT-136AUS

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File Listing:

Doc. Name	File Name	Size (Bytes)	Date Produced (yyyymmdd)
us-ids	MIT-136AUS-usidst.xml	1070	2004-10-04
us-ids	us-ids.dtd	7763	2004-10-04
us-ids	us-ids.xml	12026	2004-10-04
package-data	MIT-136AUS-pkda.xml	1711	2004-10-04
package-data	package-data.dtd	27025	2004-10-04
package-data	us-package-data.xml	19263	2004-10-04
Total files size		68858	

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